PC	N Nu	mber:		312070			Date:	De	ece	mber 1	8, 2018
Titl	e:	Datasheet for	r DS9)UB95	4-Q	1					
Cus	stom	er Contact:	<u>PCN</u>	<u>Manag</u>	er				De	pt:	Quality Services
Cha	ange	Туре:									
	Asse	embly Site				Design					Bump Site
Assembly Process					🛛 Data Sheet					Wafer	Bump Material
Assembly Materials					Part number chan						Bump Process
	Mechanical Specification					Test Site					Fab Site
Packing/Shipping/Labelir				ng		Test Process		┥└			Fab Materials
Wafer Fab Proces									Fab Process		
Notification Details											
Description of Change: Texas Instruments Incorporated is announcing an information only notification.											
The product datasheet(s) is being updated as summarized below. The following change history provides further details.											
		KAS STRUMENTS									DS90UB954-Q
_	114	STROMENTS					s	NLS	570E	AUGUST	2017-REVISED DECEMBER 201
• (Change	ed the intended co theet number	ontent ba	ndwidth	limit	t from 2.528 Gbps to	3.328 Gbps				Page
De	evice	Family					Change F	ror	n:		Change To:
DS90UB954-Q1						SNLS570A				SNLS570B	
			e revie	wed at	the	e datasheet links	provided				
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/DS90UB954-Q1											
Rea	ason	for Change:									
To a	accur	ately reflect d	evice d	haract	eris	stics.					
Ant	ticipa	ted impact o	on Fit,	Form	, Fi	unction, Quality	y or Relia	abi	lity	/ (posi	tive / negative):
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.											
Cha	ange	s to product	identi	ficatio	on i	resulting from	this PCN:				
Non	ne.										
Pro	duct	Affected:									
-		3954TRGZRQ1		901 IR	954	TRGZTQ1					
For	ques		g this	notice,	, e-	mails can be sen	t to the re	egi	ona	al conta	icts shown below

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com